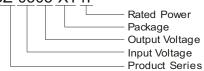


CE

DBZ XT1P 1W, FIXED INPUT, ISOLATED & UNREGULATED SINGLE OUTPUT PART NUMBER SYSTEM

DBZ-0505-XT1P





FEATURES

- Miniature SMD package
- 1500VDC isolation
- Operating temperature range: • -40°C~+105°C
- Internal SMD construction
- No external component required
- Industry standard pinout
- continuous short circut protection

APPLICATIONS The DBZ_XT1P Series are designed for application where isolated output is required from a distributed power system. These products apply to where:

- 1. Input voltage variation $\leq \pm 10\%$;
- 1.5KVDC input and output isolation; 2.
- 3. Low ripple noise is not required.

Such as: digital circuit, low frequency analog circuit, and relay drive circuit.

SELECTION (Input Voltage(VDC)	Output Voltage	Output Current (mA)		Input Current (mA)(Typ.)		Reflected Ripple	Max.Capacitive	Efficiency (%, Typ.)
Model	Nominal (Range)	(VDC)	Max.	Min.	@Max. Load	@No Load	Current (mA.Typ.)	Load(µF)	@Max. Load
DBZ-0303-XT1P	3.3	3.3	303	30	415	25			73
DBZ-0305-XT1P	(2.97-3.63)	5	200	20	388	20			78
DBZ-0503-XT1P		3.3	303	30	263				76
DBZ-0505-XT1P		5	200	20	250	20	15	220	80
DBZ-0509-XT1P	5	9	111	12	250				80
DBZ-0512-XT1P	(4.5-5.5)	12	84	9	250				80
DBZ-0515-XT1P		15	67	7	250				80
DBZ-0524-XT1P		24	42	4	250				80
DBZ-1203-XT1P	-	3.3	303	30	111	15			75
DBZ-1205-XT1P		5	200	20	104				80
DBZ-1209-XT1P	12 (10.8-13.2)	9	111	12	104				80
DBZ-1212-XT1P	(10.0 10.2)	12	84	9	103				81
DBZ-1215-XT1P		15	67	7	103				81
DBZ-1515-XT1P	15 (13.5-16.5)	15	67	7	82	10			81
DBZ-2405-XT1P		5	200	20	52				80
DBZ-2409-XT1P	24	9	110	11	52	7			80
DBZ-2415-XT1P	(21.6-26.4)	15	67	7	51			-	81
DBZ-2424-XT1P		24	42	4	51	1			81

INPUT SPECIFICATIONS					
Item	Test Conditions	Min.	Тур.	Max.	Unit
Input Surge Voltage (1 sec. max.)	3.3VDC Input	-0.7		5	
	5VDC Input	-0.7		9	
	12VDC Input	-0.7		18	VDC
	15VDC Input	-0.7		21	
	24VDC Input	-0.7		30	
Input Filter		Capacitance Filter			

The information and specifications contained in this data sheet are believed to be correct at time of publication. However, **ZimTec Electronics** accepts no responsibility for consequences arising from printing errors or inaccuracies. Specifications are subject to change without notice. No rights under any patent accompany the sale of any such product(s) or information contained herein



Item	Test Conditions	Test Conditions		Тур.	Max.	Unit	
Output Voltage Accuracy				See tolerance envelope curve			
Line Regulation	For Vin change of±1%	3.3V output			±1.5	_	
		Others			±1.2		
	10% to 100% load	3.3V output		18			
		5V output		12		~~~~% 	
Les d De sudation		9V output		8			
Load Regulation		12V output		7			
		15V output		6			
		24V output		5			
Temperature Drift	100% load				±0.03	%/°C	
Dinula 9 Mainat		Output Voltage ≤12V		30			
Ripple & Noise*	20MHz Bandwidth	Output Voltage: 15V, 24V		60		– mVp-p	
Short Circuit Protection				Continuous, au	tomatic recover	У	

Note:* Ripple and noise tested with "parallel cable" method. See detailed operation instructions at DC-DC Application Notes.

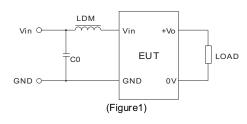
COMMON SPECIFICATIONS						
Item	Test Conditions	Min.	Тур.	Max.	Unit	
Isolation Voltage	Input-Output, tested for 1 minute and leakage current less than 1 mA	1500			VDC	
Isolation Resistance	Input-Output, test at 500VDC	1000			MΩ	
Isolation Capacitance	Inpu-Output,100KHz/0.1V		20		pF	
Switching Frequency	Full load, nominal input		100	300	KHz	
MTBF	MIL-HDBK-217F@25℃	3500			K hours	
Case Material		Epoxy Resin (UL94-V0)				
Weight			1.5		g	

ENVIRONMENTAL SPECIFICATIONS					
Item	Test Conditions	Min.	Тур.	Max.	Unit
Storage Humidity	Non condensing			95	%
Operating Temperature	Power derating (above100°C, see Figure 2)	-40		105	
Storage Temperature		-55		125	°C
Temp. rise at full load	Ta=25°C		25		
Lead Temperature	1.5mm from case for 10 seconds			300	
Cooling		Free air convection			

EMC SPECIFICATIONS						
EMI	CE	CISPR22/EN55022 CLASS B (Recommended Circuit Refer to Figure1)				
	RE	CISPR22/EN55022 CLASS B (Recommended Circuit Refer to Figure1)				
EMS	ESD	IEC/EN61000-4-2 Contact ±8KV perf. Criteria B				

EMI RECOMMENDED CIRCUIT

EMI Typical Recommended Circuit(CLASS B):



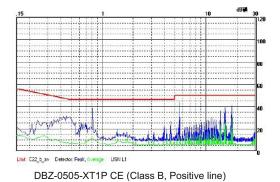
Recommended external circuit parameters:

	Vin(V)	3.3/5/12/15/24
FMI	C0	4.7µF /50V
	LDM	6.8µH

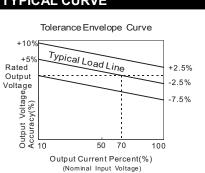
The models listed above is just for standard type. If you need the special specification product, please contact our service member by telephone presented in shortform cover or e-mail to : info@zimtec-electronics.de



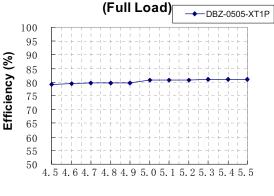
EMI TEST WAVEFORM (RECOMMENDED CIRCUIT FINGURE 1)



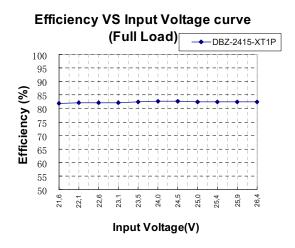
PRODUCT TYPICAL CURVE

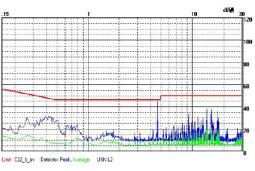


Efficiency VS Input Voltage curve



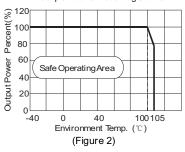
Input Voltage(V)



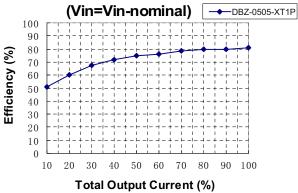


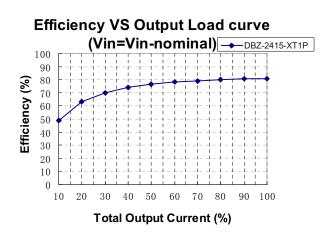
DBZ-0505-XT1P CE (Class B, Negative line)

Temperature DeratingCurve



Efficiency VS Output Load curve

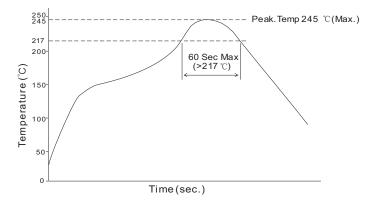




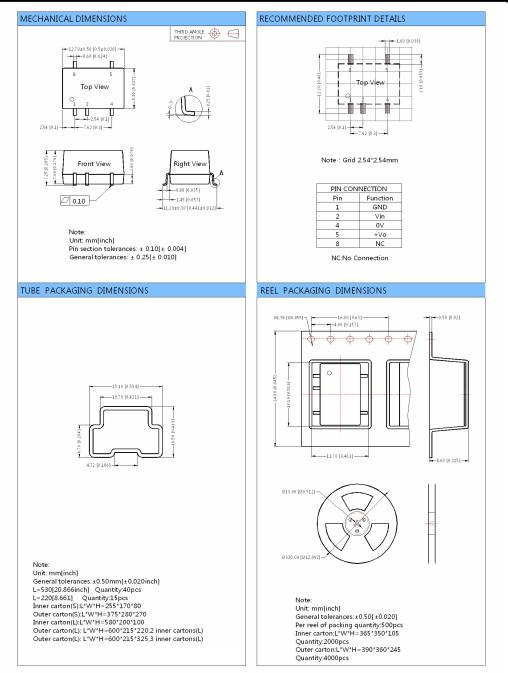
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Recommended reflow soldering profile refer to IPC/JEDEC J-STD-020D standard, our products recommend reflow soldering profile as follows:



DIMENSIONS, RECOMMENDED FOOTPRINT & PACKAGING



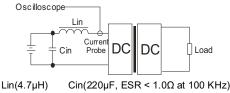
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TEST CONFIGURATIONS

Input Reflected-Ripple Current Test Setup

Input reflected-ripple current is measured with an inductor Lin and Capacitor Cin to simulate source impedance.



DESIGN CONSIDERATIONS

1) Requirement on output load

To ensure this module can operate efficiently and reliably, During operation, the minimum output load could not be less than 10% of the full load. If the actual output power is very small, please connect a resistor with proper resistance at the output end in parallel to increase the load.

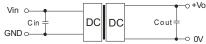
2) Overload Protection

Under normal operating conditions, the output circuit of these products has no protection against overload. The simplest method is to add a circuit breaker to the circuit.

3) Recommended circuit

If you want to further decrease the input/output ripple, an capacitor filtering network may be connected to the input and output ends of the DC/DC converter, see (Figure 3).

It should also be noted that the capacitance of filter capacitor must be proper. If the capacitance is too big, a startup problem might arise. For every channel of output, provided the safe and reliable operation is ensured, the recommended capacitance of its filter capacitor sees (Table 1).



(Figure 3)

EXTERNAL CAPACITOR TABLE (Table 1)

Vin (VDC)	Cin (µF)	Vo (VDC)	Cout (µF)
3.3	4.7	3.3	10
5	4.7	5	10
12	2.2	9	4.7
15	2.2	12	2.2
24	1	15	1
-		24	0.47

It's not recommended to connect any external capacitor in the application field with less than 0.5 watt output.

4) The input and the output of the product are recommended to be connected to ceramic capacitor or electrolytic capacitor. Using tantalum capacitor may cause risk of failure

5) It is not recommended to increase the output power capability by connecting two or more converters in parallel. The product is not hot-swappable

Note:

1. Operation under minimum load will not damage the converter; However, they may not meet all specifications.

- 2. Max. Capacitive Load is tested at nominal input voltage and full load.
- 3. Unless otherwise noted, All specifications are measured at Ta=25°C, humidity<75%, nominal input voltage and rated output load.
- 4. In this datasheet, all test methods are based on our corporate standards.
- 5. All characteristics are for listed models, and non-standard models may perform differently. Please contact our technical support for more detail.
- 6. Please contact our technical support for any specific requirement.
- 7. Specifications of this product are subject to changes without prior notice.

ZimTec Electronics GmbH

Kirchstraße 5-6, 39606 Osterburg, Germany E-mail: info@zimtec-electronics.de Web: www.zimtec-electronics.de